Renesas Electronics America Inc - R5F51111ADFK#3A Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, SCI, SPI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	46
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 14x12b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51111adfk-3a

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no., memory capacity, and package type.

Table 1.3 List of Products (1/2)

Group	Part No.	Orderable Part No.	Package	ROM Capacity	RAM Capacity	E2 DataFlash	Maximum Operating Frequency	Operating Temperature
RX111	R5F51118AGFM	R5F51118AGFM#3A	PLQP0064KB-A	512 Kbytes	64 Kbytes	8 Kbytes	32 MHz	–40 to +105°C
	R5F51118AGFK	R5F51118AGFK#3A	PLQP0064GA-A					
	R5F51118AGFL	R5F51118AGFL#3A	PLQP0048KB-A					
	R5F51118AGNE	R5F51118AGNE#UA	PWQN0048KB-A					
	R5F51117AGFM	R5F51117AGFM#3A	PLQP0064KB-A	384 Kbytes				
	R5F51117AGFK	R5F51117AGFK#3A	PLQP0064GA-A					
	R5F51117AGFL	R5F51117AGFL#3A	PLQP0048KB-A					
	R5F51117AGNE	R5F51117AGNE#UA	PWQN0048KB-A					
	R5F51116AGFM	R5F51116AGFM#3A	PLQP0064KB-A	256 Kbytes	32 Kbytes			
	R5F51116AGFK	R5F51116AGFK#3A	PLQP0064GA-A					
	R5F51116AGFL	R5F51116AGFL#3A	PLQP0048KB-A					
	R5F51116AGNE	R5F51116AGNE#UA	PWQN0048KB-A					
	R5F51115AGFM	R5F51115AGFM#3A	PLQP0064KB-A	128 Kbytes	16 Kbytes			
	R5F51115AGFK	R5F51115AGFK#3A	PLQP0064GA-A					
	R5F51115AGFL	R5F51115AGFL#3A	PLQP0048KB-A					
	R5F51115AGNE	R5F51115AGNE#UA	PWQN0048KB-A					
	R5F51114AGFM	R5F51114AGFM#3A	PLQP0064KB-A	96 Kbytes				
	R5F51114AGFK	R5F51114AGFK#3A	PLQP0064GA-A					
	R5F51114AGFL	R5F51114AGFL#3A	PLQP0048KB-A					
	R5F51114AGNE	R5F51114AGNE#UA	PWQN0048KB-A					
	R5F51113AGFM	R5F51113AGFM#3A	PLQP0064KB-A	64 Kbytes	10 Kbytes			
	R5F51113AGFK	R5F51113AGFK#3A	PLQP0064GA-A					
	R5F51113AGFL	R5F51113AGFL#3A	PLQP0048KB-A					
	R5F51113AGNE	R5F51113AGNE#UA	PWQN0048KB-A					
	R5F51113AGNF	R5F51113AGNF#UA	PWQN0040KC-A					
	R5F51111AGFM	R5F51111AGFM#3A	PLQP0064KB-A	32 Kbytes				
	R5F51111AGFK	R5F51111AGFK#3A	PLQP0064GA-A					
	R5F51111AGFL	R5F51111AGFL#3A	PLQP0048KB-A					
	R5F51111AGNE	R5F51111AGNE#UA	PWQN0048KB-A					
	R5F51111AGNF	R5F51111AGNF#UA	PWQN0040KC-A					
	R5F5111JAGFM	R5F5111JAGFM#3A	PLQP0064KB-A	16 Kbytes	8 Kbytes			
	R5F5111JAGFK	R5F5111JAGFK#3A	PLQP0064GA-A					
	R5F5111JAGFL	R5F5111JAGFL#3A	PLQP0048KB-A					
	R5F5111JAGNE	R5F5111JAGNE#UA	PWQN0048KB-A					
	R5F5111JAGNF	R5F5111JAGNF#UA	PWQN0040KC-A					

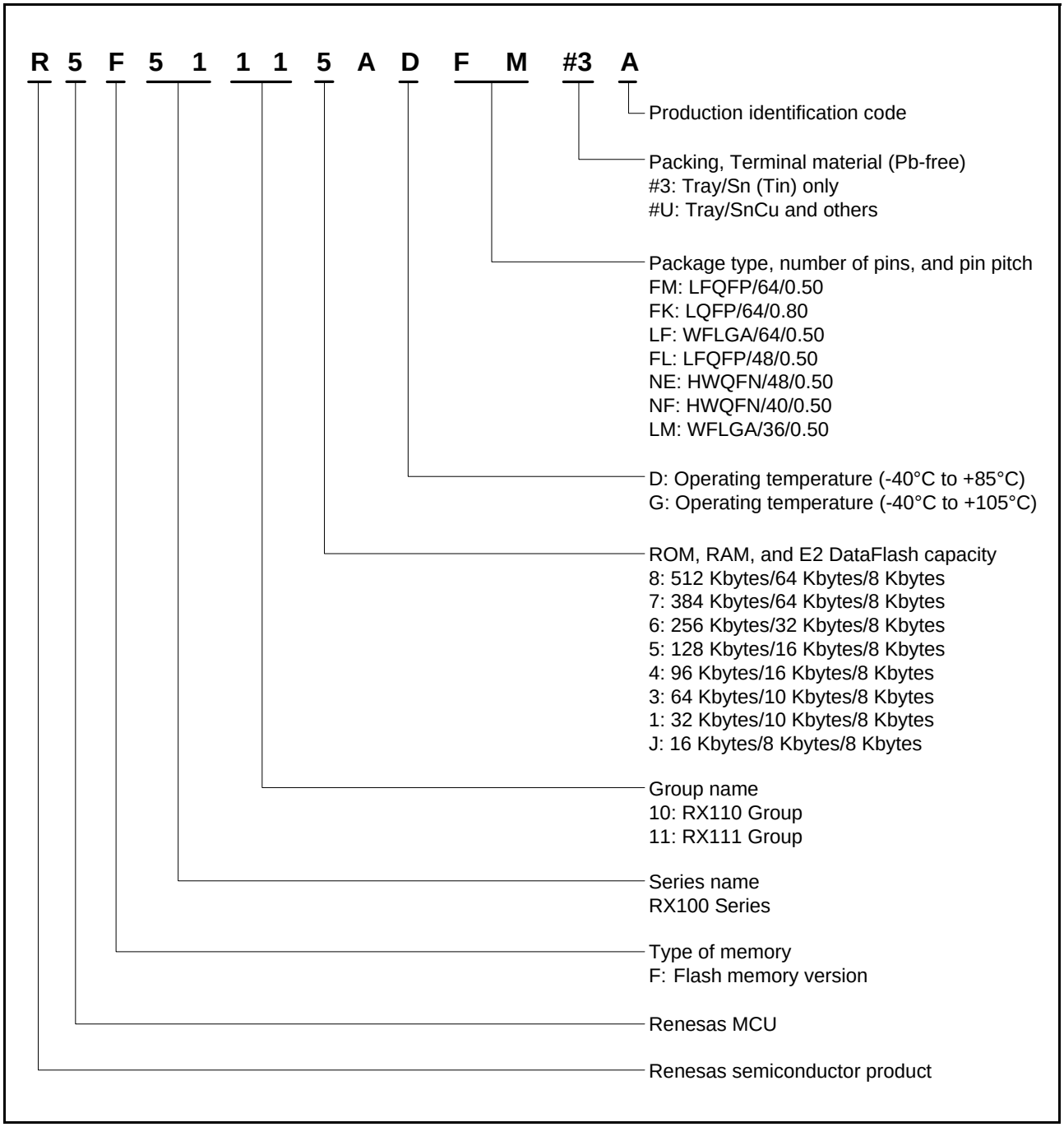


Figure 1.1 How to Read the Product Part No., Memory Capacity, and Package Type

Table 1.8 List of Pins and Pin Functions (40-Pin HWQFN) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
1		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/CACREF/ ADTRG0#
2		P26	MTIOC2A	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN	
3	MD				FINED
4	RES#				
5	UPSEL	P35			NMI
6	XTAL				
7	EXTAL				
8	VCL				
9	VSS				
10	VCC				
11		P32	MTIOC0C		IRQ2
12		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12	IRQ7
13		P16	MTIOC3C/MTIOC3D	TXD1/SMOSI1/SSDA1/SCL0/ MOSIA/USB0_VBUSEN/ USB0_OVRCURB/USB0_VBUS	IRQ6/ADTRG0#
14		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
15	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/ TXDX12/SIOX12/SMOSI12/ SSDA12/USB0_OVRCURA	IRQ4
16	VCC_USB				
17				USB0_DM	
18				USB0_DP	
19	VSS_USB				
20		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUS*1/ USB0_VBUSEN	IRQ2/CLKOUT
21		PB3	MTIOC0A/MTIOC3B/ MTIOC4A/POE3#	USB0_OVRCURA	
22	VCC				
23		PB0	MTIOC0C/MTIC5W	SCL0/RSPCKA	IRQ2/ADTRG0#
24	VSS				
25		PA6	MTIOC2A/MTIC5V/MTCLKB/ POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
26		PA4	MTIOC2B/MTIC5U/MTCLKA	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
27		PA3	MTIOC0D/MTIOC1B/ MTCLKD/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
28		PA1	MTIOC0B/MTCLKC	SCK5/SSLA2	
29		PE4	MTIOC1A/MTIOC3A/ MTIOC4D	MOSIA	IRQ4/AN012
30		PE3	MTIOC0A/MTIOC1B/ MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
31		PE2	MTIOC4A	RXD12/RXDX12/SMISO12/SSCL12	IRQ7/AN010
32		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12	IRQ1/AN009
33		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
34		P46*2			AN006
35		P42*2			AN002
36		P41*2			AN001
37	VREFL0	PJ7*2			
38	VREFH0	PJ6*2			
39	AVSS0				

Table 1.9 List of Pins and Pin Functions (36-Pin WFLGA)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
A1	AVSS0				
A2	AVCC0				
A3	VREFH0	PJ6*2			
A4		P42*2			AN002
A5		P41*2			AN001
A6		PE2	MTIOC4A	RXD12/RXDX12/SMISO12/SSCL12	IRQ7/AN010
B1	RES#				
B2		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/CACREF/ ADTRG0#
B3	VREFL0	PJ7*2			
B4		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
B5		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12	IRQ1/AN009
B6		PA3	MTIOC0D/MTCLKD/ MTIOC1B/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
C1	XTAL				
C2	MD				FINED
C3		PE3	MTIOC0A/MTIOC1B/ MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
C4		PE4	MTIOC1A/MTIOC3A/ MTIOC4D	MOSIA	IRQ4/AN012
C5		PA4	MTIOC2B/MTIC5U/MTCLKA	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
C6	VSS				
D1	EXTAL				
D2	UPSEL	P35			NMI
D3	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/ TXDX12/SIOX12/SMOSI12/ SSDA12/USB0_OVRCURA	IRQ4
D4		PA6	MTIC5V/MTCLKB/MTIOC2A/ POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
D5		PB3	MTIOC0A/MTIOC3B/ MTIOC4A/POE3#	USB0_OVRCURA	
D6		PB0	MTIOC0C/MTIC5W	SCL0/RSPCKA	IRQ2/ADTRG0#
E1	VCL				
E2		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12	IRQ7
E3		P16	MTIOC3C/MTIOC3D	TXD1/SMOSI1/SSDA1/SCL0/ MOSIA/USB0_VBUSEN/ USB0_OVRCURB/USB0_VBUS	IRQ6/ADTRG0#
E4		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
E5		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUSEN/ USB0_VBUS*1	IRQ2/CLKOUT
E6	VCC				
F1	VSS				
F2	VCC				
F3	VCC_USB				
F4				USB0_DM	
F5				USB0_DP	
F6	VSS_USB				

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

Table 4.1 List of I/O Registers (Address Order) (2/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 7026h	ICU	Interrupt Request Register 038	IR038	8	8	2 ICLK
0008 702Ch	ICU	Interrupt Request Register 044	IR044	8	8	2 ICLK
0008 702Dh	ICU	Interrupt Request Register 045	IR045	8	8	2 ICLK
0008 702Eh	ICU	Interrupt Request Register 046	IR046	8	8	2 ICLK
0008 702Fh	ICU	Interrupt Request Register 047	IR047	8	8	2 ICLK
0008 7039h	ICU	Interrupt Request Register 057	IR057	8	8	2 ICLK
0008 703Fh	ICU	Interrupt Request Register 063	IR063	8	8	2 ICLK
0008 7040h	ICU	Interrupt Request Register 064	IR064	8	8	2 ICLK
0008 7041h	ICU	Interrupt Request Register 065	IR065	8	8	2 ICLK
0008 7042h	ICU	Interrupt Request Register 066	IR066	8	8	2 ICLK
0008 7043h	ICU	Interrupt Request Register 067	IR067	8	8	2 ICLK
0008 7044h	ICU	Interrupt Request Register 068	IR068	8	8	2 ICLK
0008 7045h	ICU	Interrupt Request Register 069	IR069	8	8	2 ICLK
0008 7046h	ICU	Interrupt Request Register 070	IR070	8	8	2 ICLK
0008 7047h	ICU	Interrupt Request Register 071	IR071	8	8	2 ICLK
0008 7058h	ICU	Interrupt Request Register 088	IR088	8	8	2 ICLK
0008 7059h	ICU	Interrupt Request Register 089	IR089	8	8	2 ICLK
0008 705Ah	ICU	Interrupt Request Register 090	IR090	8	8	2 ICLK
0008 705Ch	ICU	Interrupt Request Register 092	IR092	8	8	2 ICLK
0008 705Dh	ICU	Interrupt Request Register 093	IR093	8	8	2 ICLK
0008 7066h	ICU	Interrupt Request Register 102	IR102	8	8	2 ICLK
0008 7067h	ICU	Interrupt Request Register 103	IR103	8	8	2 ICLK
0008 706Ah	ICU	Interrupt Request Register 106	IR106	8	8	2 ICLK
0008 7072h	ICU	Interrupt Request Register 114	IR114	8	8	2 ICLK
0008 7073h	ICU	Interrupt Request Register 115	IR115	8	8	2 ICLK
0008 7074h	ICU	Interrupt Request Register 116	IR116	8	8	2 ICLK
0008 7075h	ICU	Interrupt Request Register 117	IR117	8	8	2 ICLK
0008 7076h	ICU	Interrupt Request Register 118	IR118	8	8	2 ICLK
0008 7077h	ICU	Interrupt Request Register 119	IR119	8	8	2 ICLK
0008 7078h	ICU	Interrupt Request Register 120	IR120	8	8	2 ICLK
0008 7079h	ICU	Interrupt Request Register 121	IR121	8	8	2 ICLK
0008 707Ah	ICU	Interrupt Request Register 122	IR122	8	8	2 ICLK
0008 707Bh	ICU	Interrupt Request Register 123	IR123	8	8	2 ICLK
0008 707Ch	ICU	Interrupt Request Register 124	IR124	8	8	2 ICLK
0008 707Dh	ICU	Interrupt Request Register 125	IR125	8	8	2 ICLK
0008 707Eh	ICU	Interrupt Request Register 126	IR126	8	8	2 ICLK
0008 707Fh	ICU	Interrupt Request Register 127	IR127	8	8	2 ICLK
0008 7080h	ICU	Interrupt Request Register 128	IR128	8	8	2 ICLK
0008 7081h	ICU	Interrupt Request Register 129	IR129	8	8	2 ICLK
0008 7082h	ICU	Interrupt Request Register 130	IR130	8	8	2 ICLK
0008 7083h	ICU	Interrupt Request Register 131	IR131	8	8	2 ICLK
0008 7084h	ICU	Interrupt Request Register 132	IR132	8	8	2 ICLK
0008 7085h	ICU	Interrupt Request Register 133	IR133	8	8	2 ICLK
0008 7086h	ICU	Interrupt Request Register 134	IR134	8	8	2 ICLK
0008 7087h	ICU	Interrupt Request Register 135	IR135	8	8	2 ICLK
0008 7088h	ICU	Interrupt Request Register 136	IR136	8	8	2 ICLK
0008 7089h	ICU	Interrupt Request Register 137	IR137	8	8	2 ICLK
0008 708Ah	ICU	Interrupt Request Register 138	IR138	8	8	2 ICLK
0008 708Bh	ICU	Interrupt Request Register 139	IR139	8	8	2 ICLK
0008 708Ch	ICU	Interrupt Request Register 140	IR140	8	8	2 ICLK
0008 708Dh	ICU	Interrupt Request Register 141	IR141	8	8	2 ICLK
0008 70AAh	ICU	Interrupt Request Register 170	IR170	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (6/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 7594h	ICU	NMI Pin Digital Filter Setting Register	NMIFLTC	8	8	2 ICLK
0008 8000h	CMT	Compare Match Timer Start Register 0	CMSTR0	16	16	2 or 3 PCLKB
0008 8002h	CMT0	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 8004h	CMT0	Compare Match Timer Counter	CMCNT	16	16	2 or 3 PCLKB
0008 8006h	CMT0	Compare Match Timer Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8008h	CMT1	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 800Ah	CMT1	Compare Match Timer Counter	CMCNT	16	16	2 or 3 PCLKB
0008 800Ch	CMT1	Compare Match Timer Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8030h	IWDT	IWDT Refresh Register	IWDTRR	8	8	2 or 3 PCLKB
0008 8032h	IWDT	IWDT Control Register	IWDTCR	16	16	2 or 3 PCLKB
0008 8034h	IWDT	IWDT Status Register	IWDTSR	16	16	2 or 3 PCLKB
0008 8036h	IWDT	IWDT Reset Control Register	IWDTRCR	8	8	2 or 3 PCLKB
0008 8038h	IWDT	IWDT Count Stop Control Register	IWDTCSTPR	8	8	2 or 3 PCLKB
0008 80C0h	DA	D/A Data Register 0	DADR0	16	16	2 or 3 PCLKB
0008 80C2h	DA	D/A Data Register 1	DADR1	16	16	2 or 3 PCLKB
0008 80C4h	DA	D/A Control Register	DACR	8	8	2 or 3 PCLKB
0008 80C5h	DA	DADRm Format Select Register	DADPR	8	8	2 or 3 PCLKB
0008 8280h	CRC	CRC Control Register	CRCCR	8	8	2 or 3 PCLKB
0008 8281h	CRC	CRC Data Input Register	CRCDIR	8	8	2 or 3 PCLKB
0008 8282h	CRC	CRC Data Output Register	CRCDOR	16	16	2 or 3 PCLKB
0008 8300h	RIIC0	I^2C Bus Control Register 1	ICCR1	8	8	2 or 3 PCLKB
0008 8301h	RIIC0	I^2C Bus Control Register 2	ICCR2	8	8	2 or 3 PCLKB
0008 8302h	RIIC0	I^2C Bus Mode Register 1	ICMR1	8	8	2 or 3 PCLKB
0008 8303h	RIIC0	I^2C Bus Mode Register 2	ICMR2	8	8	2 or 3 PCLKB
0008 8304h	RIIC0	I^2C Bus Mode Register 3	ICMR3	8	8	2 or 3 PCLKB
0008 8305h	RIIC0	I^2C Bus Function Enable Register	ICFER	8	8	2 or 3 PCLKB
0008 8306h	RIIC0	I^2C Bus Status Enable Register	ICSER	8	8	2 or 3 PCLKB
0008 8307h	RIIC0	I^2C Bus Interrupt Enable Register	ICIER	8	8	2 or 3 PCLKB
0008 8308h	RIIC0	I^2C Bus Status Register 1	ICSR1	8	8	2 or 3 PCLKB
0008 8309h	RIIC0	I^2C Bus Status Register 2	ICSR2	8	8	2 or 3 PCLKB
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2 or 3 PCLKB
0008 830Ah	RIIC0	Timeout Internal Counter L	TMOCNTL	8	8	2 or 3 PCLKB
0008 830Bh	RIIC0	Slave Address Register U0	SARU0	8	8	2 or 3 PCLKB
0008 830Bh	RIIC0	Timeout Internal Counter U	TMOCNTU	8	8 *1	2 or 3 PCLKB
0008 830Ch	RIIC0	Slave Address Register L1	SARL1	8	8	2 or 3 PCLKB
0008 830Dh	RIIC0	Slave Address Register U1	SARU1	8	8	2 or 3 PCLKB
0008 830Eh	RIIC0	Slave Address Register L2	SARL2	8	8	2 or 3 PCLKB
0008 830Fh	RIIC0	Slave Address Register U2	SARU2	8	8	2 or 3 PCLKB
0008 8310h	RIIC0	I^2C Bus Bit Rate Low-Level Register	ICBRL	8	8	2 or 3 PCLKB
0008 8311h	RIIC0	I^2C Bus Bit Rate High-Level Register	ICBRH	8	8	2 or 3 PCLKB
0008 8312h	RIIC0	I^2C Bus Transmit Data Register	ICDRT	8	8	2 or 3 PCLKB
0008 8313h	RIIC0	I^2C Bus Receive Data Register	ICDRR	8	8	2 or 3 PCLKB
0008 8380h	RSPI0	RSPI Control Register	SPCR	8	8	2 or 3 PCLKB
0008 8381h	RSPI0	RSPI Slave Select Polarity Register	SSLP	8	8	2 or 3 PCLKB
0008 8382h	RSPI0	RSPI Pin Control Register	SPPCR	8	8	2 or 3 PCLKB
0008 8383h	RSPI0	RSPI Status Register	SPSR	8	8	2 or 3 PCLKB
0008 8384h	RSPI0	RSPI Data Register	SPDR	32	16, 32	2 or 3 PCLKB/2ICLK
0008 8388h	RSPI0	RSPI Sequence Control Register	SPSCR	8	8	2 or 3 PCLKB
0008 8389h	RSPI0	RSPI Sequence Status Register	SPSSR	8	8	2 or 3 PCLKB
0008 838Ah	RSPI0	RSPI Bit Rate Register	SPBR	8	8	2 or 3 PCLKB
0008 838Bh	RSPI0	RSPI Data Control Register	SPDCR	8	8	2 or 3 PCLKB
0008 838Ch	RSPI0	RSPI Clock Delay Register	SPCKD	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (7/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 838Dh	RSPI0	RSPI Slave Select Negation Delay Register	SSLND	8	8	2 or 3 PCLKB
0008 838Eh	RSPI0	RSPI Next-Access Delay Register	SPND	8	8	2 or 3 PCLKB
0008 838Fh	RSPI0	RSPI Control Register 2	SPCR2	8	8	2 or 3 PCLKB
0008 8390h	RSPI0	RSPI Command Register 0	SPCMD0	16	16	2 or 3 PCLKB
0008 8392h	RSPI0	RSPI Command Register 1	SPCMD1	16	16	2 or 3 PCLKB
0008 8394h	RSPI0	RSPI Command Register 2	SPCMD2	16	16	2 or 3 PCLKB
0008 8396h	RSPI0	RSPI Command Register 3	SPCMD3	16	16	2 or 3 PCLKB
0008 8398h	RSPI0	RSPI Command Register 4	SPCMD4	16	16	2 or 3 PCLKB
0008 839Ah	RSPI0	RSPI Command Register 5	SPCMD5	16	16	2 or 3 PCLKB
0008 839Ch	RSPI0	RSPI Command Register 6	SPCMD6	16	16	2 or 3 PCLKB
0008 839Eh	RSPI0	RSPI Command Register 7	SPCMD7	16	16	2 or 3 PCLKB
0008 8600h	MTU3	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8601h	MTU4	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8602h	MTU3	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8603h	MTU4	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8604h	MTU3	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8605h	MTU3	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8606h	MTU4	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8607h	MTU4	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8608h	MTU3	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8609h	MTU4	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 860Ah	MTU	Timer Output Master Enable Register	TOER	8	8	2 or 3 PCLKB
0008 860Dh	MTU	Timer Gate Control Register	TGCR	8	8	2 or 3 PCLKB
0008 860Eh	MTU	Timer Output Control Register 1	TOCR1	8	8	2 or 3 PCLKB
0008 860Fh	MTU	Timer Output Control Register 2	TOCR2	8	8	2 or 3 PCLKB
0008 8610h	MTU3	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8612h	MTU4	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8614h	MTU	Timer Cycle Data Register	TCDR	16	16	2 or 3 PCLKB
0008 8616h	MTU	Timer Dead Time Data Register	TDDR	16	16	2 or 3 PCLKB
0008 8618h	MTU3	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 861Ah	MTU3	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 861Ch	MTU4	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 861Eh	MTU4	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8620h	MTU	Timer Subcounter	TCNTS	16	16	2 or 3 PCLKB
0008 8622h	MTU	Timer Cycle Buffer Register	TCBR	16	16	2 or 3 PCLKB
0008 8624h	MTU3	Timer General Register C	TGRC	16	16	2 or 3 PCLKB
0008 8626h	MTU3	Timer General Register D	TGRD	16	16	2 or 3 PCLKB
0008 8628h	MTU4	Timer General Register C	TGRC	16	16	2 or 3 PCLKB
0008 862Ah	MTU4	Timer General Register D	TGRD	16	16	2 or 3 PCLKB
0008 862Ch	MTU3	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 862Dh	MTU4	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8630h	MTU	Timer Interrupt Skipping Set Register	TITCR	8	8	2 or 3 PCLKB
0008 8631h	MTU	Timer Interrupt Skipping Counter	TITCNT	8	8	2 or 3 PCLKB
0008 8632h	MTU	Timer Buffer Transfer Set Register	TBTER	8	8	2 or 3 PCLKB
0008 8634h	MTU	Timer Dead Time Enable Register	TDER	8	8	2 or 3 PCLKB
0008 8636h	MTU	Timer Output Level Buffer Register	TOLBR	8	8	2 or 3 PCLKB
0008 8638h	MTU3	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8639h	MTU4	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8640h	MTU4	Timer A/D Converter Start Request Control Register	TADCR	16	16	2 or 3 PCLKB
0008 8644h	MTU4	Timer A/D Converter Start Request Cycle Set Register A	TADCORA	16	16	2 or 3 PCLKB
0008 8646h	MTU4	Timer A/D Converter Start Request Cycle Set Register B	TADCORB	16	16	2 or 3 PCLKB
0008 8648h	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register A	TADCOBRA	16	16	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (8/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 864Ah	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register B	TADCOBRB	16	16	2 or 3 PCLKB
0008 8660h	MTU	Timer Waveform Control Register	TWCR	8	8, 16	2 or 3 PCLKB
0008 8680h	MTU	Timer Start Register	TSTR	8	8, 16	2 or 3 PCLKB
0008 8681h	MTU	Timer Synchronous Register	TSYR	8	8, 16	2 or 3 PCLKB
0008 8684h	MTU	Timer Read/Write Enable Register	TRWER	8	8, 16	2 or 3 PCLKB
0008 8690h	MTU0	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8691h	MTU1	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8692h	MTU2	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8693h	MTU3	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8694h	MTU4	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8695h	MTU5	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKB
0008 8700h	MTU0	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8701h	MTU0	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8702h	MTU0	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8703h	MTU0	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8704h	MTU0	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8705h	MTU0	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8706h	MTU0	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8708h	MTU0	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 870Ah	MTU0	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 870Ch	MTU0	Timer General Register C	TGRC	16	16	2 or 3 PCLKB
0008 870Eh	MTU0	Timer General Register D	TGRD	16	16	2 or 3 PCLKB
0008 8720h	MTU0	Timer General Register E	TGRE	16	16	2 or 3 PCLKB
0008 8722h	MTU0	Timer General Register F	TGRF	16	16	2 or 3 PCLKB
0008 8724h	MTU0	Timer Interrupt Enable Register 2	TIER2	8	8	2 or 3 PCLKB
0008 8726h	MTU0	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8780h	MTU1	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8781h	MTU1	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8782h	MTU1	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB
0008 8784h	MTU1	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8785h	MTU1	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8786h	MTU1	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8788h	MTU1	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 878Ah	MTU1	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8790h	MTU1	Timer Input Capture Control Register	TICCR	8	8	2 or 3 PCLKB
0008 8800h	MTU2	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8801h	MTU2	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8802h	MTU2	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB
0008 8804h	MTU2	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8805h	MTU2	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8806h	MTU2	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8808h	MTU2	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 880Ah	MTU2	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8880h	MTU5	Timer Counter U	TCNTU	16	16	2 or 3 PCLKB
0008 8882h	MTU5	Timer General Register U	TGRU	16	16	2 or 3 PCLKB
0008 8884h	MTU5	Timer Control Register U	TCRU	8	8	2 or 3 PCLKB
0008 8886h	MTU5	Timer I/O Control Register U	TIORU	8	8	2 or 3 PCLKB
0008 8890h	MTU5	Timer Counter V	TCNTV	16	16	2 or 3 PCLKB
0008 8892h	MTU5	Timer General Register V	TGRV	16	16	2 or 3 PCLKB
0008 8894h	MTU5	Timer Control Register V	TCRV	8	8	2 or 3 PCLKB
0008 8896h	MTU5	Timer I/O Control Register V	TIORV	8	8	2 or 3 PCLKB
0008 88A0h	MTU5	Timer Counter W	TCNTW	16	16	2 or 3 PCLKB

[128-Kbyte or less flash memory]

Table 5.7 DC Characteristics (5) (1/2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 32 MHz	I_{CC}	3.2	—	mA	
				ICLK = 16 MHz		2.2	—		
				ICLK = 8 MHz		1.7	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		10.6	—		
				ICLK = 16 MHz		6.1	—		
				ICLK = 8 MHz		3.7	—		
			All peripheral operation: Max.*3	ICLK = 32 MHz		—	24		
		Sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.8	—		
				ICLK = 16 MHz		1.4	—		
				ICLK = 8 MHz		1.1	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		6.4	—		
				ICLK = 16 MHz		3.7	—		
				ICLK = 8 MHz		2.4	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.2	—		
				ICLK = 16 MHz		1.0	—		
				ICLK = 8 MHz		0.90	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		4.6	—		
				ICLK = 16 MHz		2.8	—		
				ICLK = 8 MHz		1.8	—		
		Increase during flash rewrite*5				2.5	—		
	Middle-speed operating modes	Normal operating mode	No peripheral operation*6	ICLK = 12 MHz	I_{CC}	2.0	—	mA	
				ICLK = 8 MHz		1.3	—		
				ICLK = 1 MHz		0.75	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		4.9	—		
				ICLK = 8 MHz		3.5	—		
				ICLK = 1 MHz		1.2	—		
			All peripheral operation: Max.*7	ICLK = 12 MHz		—	11		
		Sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.4	—		
				ICLK = 8 MHz		0.85	—		
				ICLK = 1 MHz		0.65	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		3.2	—		
				ICLK = 8 MHz		2.2	—		
				ICLK = 1 MHz		1.0	—		
		Deep sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.2	—		
				ICLK = 8 MHz		0.70	—		
				ICLK = 1 MHz		0.60	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		2.5	—		
				ICLK = 8 MHz		1.8	—		
				ICLK = 1 MHz		0.90	—		
		Increase during flash rewrite*5				2.5	—		

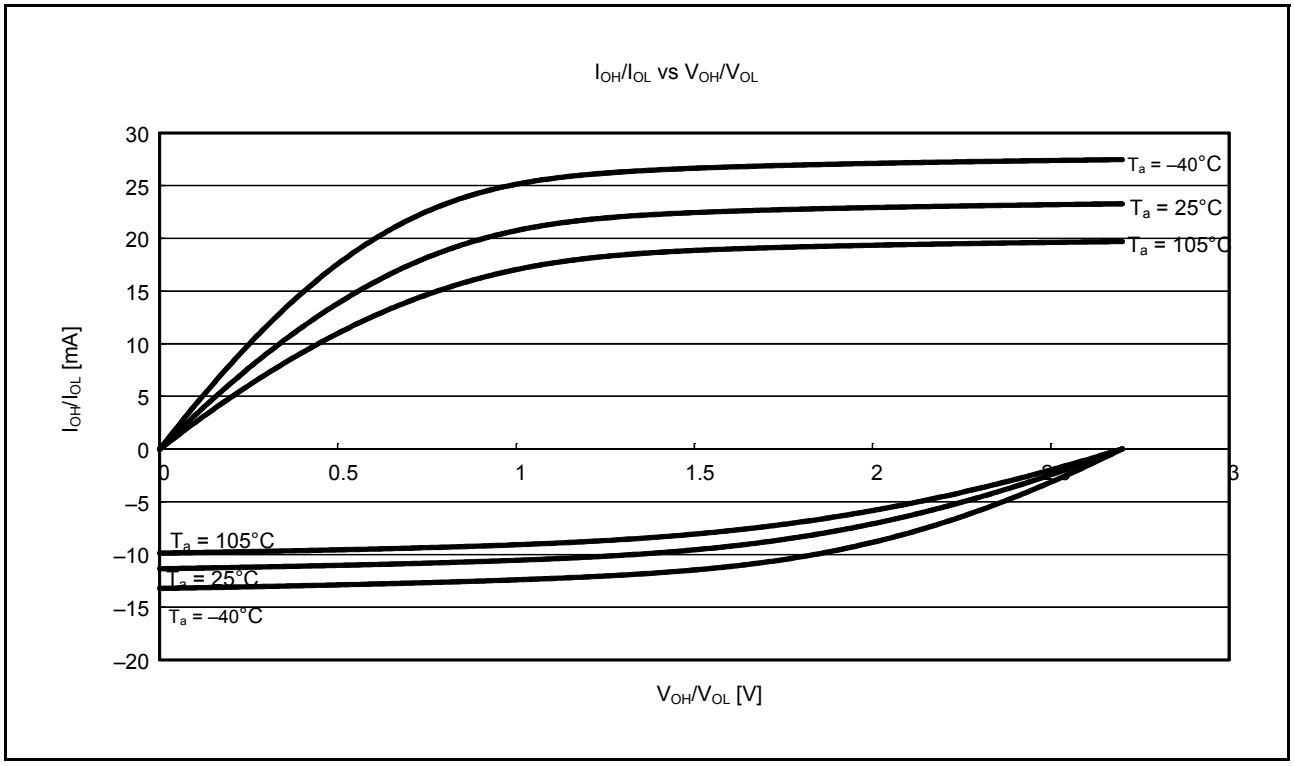


Figure 5.14 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 2.7 V (Reference Data)

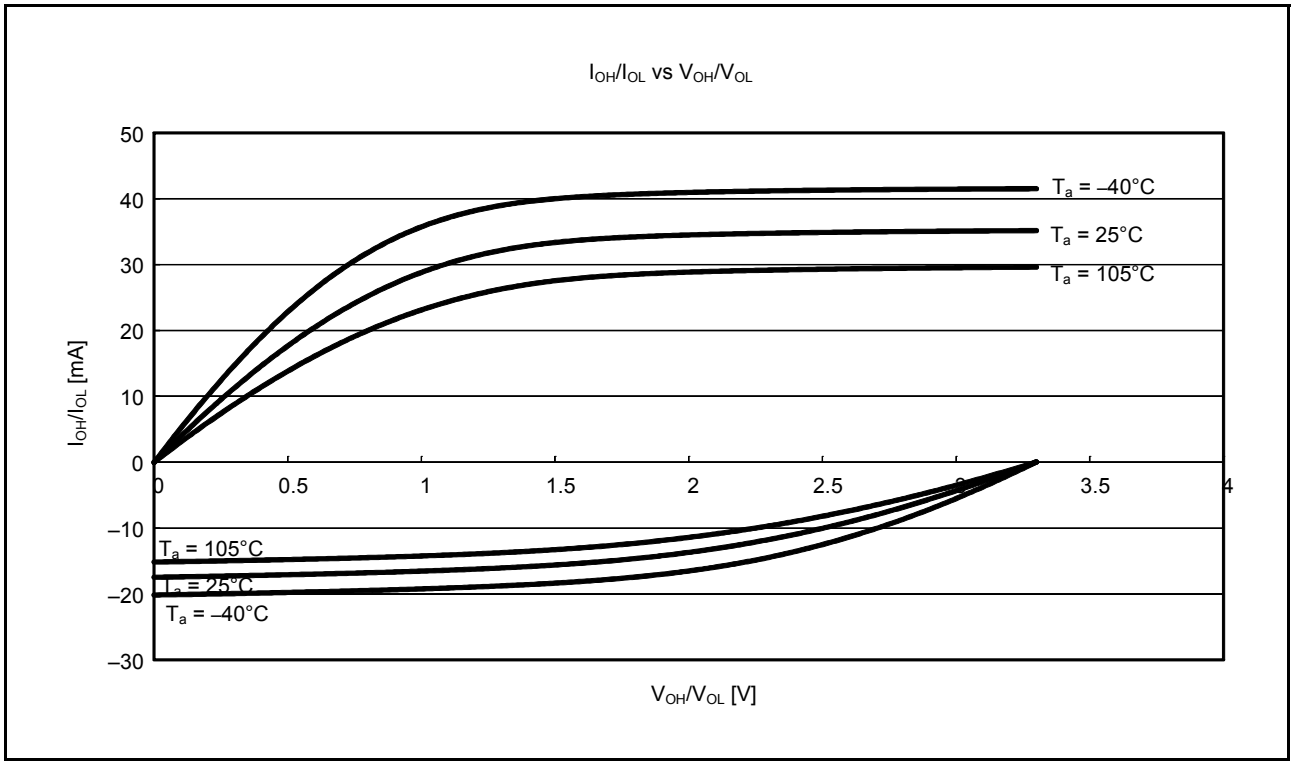


Figure 5.15 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at VCC = 3.3 V (Reference Data)

5.3 AC Characteristics

5.3.1 Clock Timing

Table 5.21 Operation Frequency Value (High-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	16	32	24	MHz
	FlashIF clock (FCLK)*1, *2		8	16	32	24	
	Peripheral module clock (PCLKB)		8	16	32	24	
	Peripheral module clock (PCLKD)*3		8	16	32	24	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK should be ±3.5%. Confirm the frequency accuracy of the clock source.
Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.
Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.22 Operation Frequency Value (Middle-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	12	12	12	MHz
	FlashIF clock (FCLK)*1, *2		8	12	12	12	
	Peripheral module clock (PCLKB)		8	12	12	12	
	Peripheral module clock (PCLKD)*3		8	12	12	12	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK should be ±3.5%.
Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.
Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.23 Operation Frequency Value (Low-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC			Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	32.768			kHz
	FlashIF clock (FCLK)*1		32.768			
	Peripheral module clock (PCLKB)		32.768			
	Peripheral module clock (PCLKD)*2		32.768			

Note 1. Programming and erasing the flash memory is impossible.
Note 2. The A/D converter cannot be used.

5.3.4 Control Signal Timing

Table 5.31 Control Signal Timing

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
NMI pulse width	t_{NMIW}	200	—	—	ns	NMI digital filter disabled (NMIFLTE.NFLTEN = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		NMI digital filter enabled (NMIFLTE.NFLTEN = 1)	t_{NMICK} × 3 ≤ 200 ns
		t_{NMICK} × 3.5*2	—	—			t_{NMICK} × 3 > 200 ns
IRQ pulse width	t_{IRQW}	200	—	—	ns	IRQ digital filter disabled (IRQFLTE0.FLTENi = 0)	t_{Pcyc} × 2 ≤ 200 ns
		t_{Pcyc} × 2*1	—	—			t_{Pcyc} × 2 > 200 ns
		200	—	—		IRQ digital filter enabled (IRQFLTE0.FLTENi = 1)	t_{IRQCK} × 3 ≤ 200 ns
		t_{IRQCK} × 3.5*3	—	—			t_{IRQCK} × 3 > 200 ns

Note: • 200 ns minimum in software standby mode.
Note 1. t_{Pcyc} indicates the cycle of PCLKB.
Note 2. t_{NMICK} indicates the cycle of the NMI digital filter sampling clock.
Note 3. t_{IRQCK} indicates the cycle of the IRQi digital filter sampling clock (i = 0 to 7).

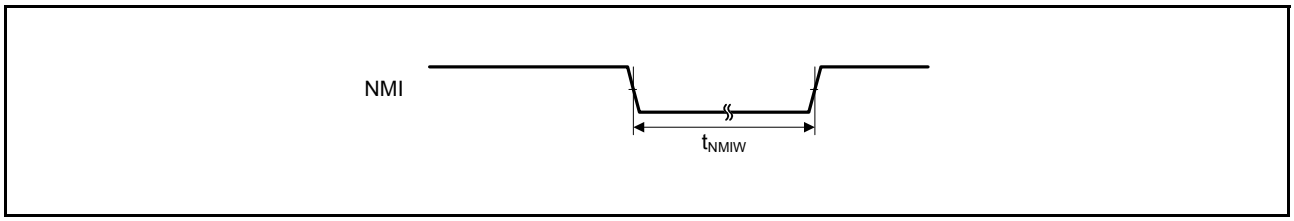


Figure 5.36 NMI Interrupt Input Timing

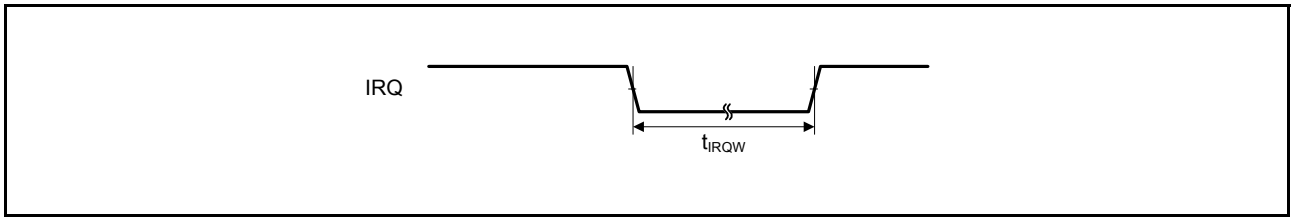


Figure 5.37 IRQ Interrupt Input Timing

Table 5.33 Timing of On-Chip Peripheral Modules (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +105°C, C = 30 pF

Item				Symbol	Min.	Max.	Unit	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc} *1	Figure 5.46
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock rise/fall time	Output	2.7 V or above	t_{SPCKr}, t_{SPCKf}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	Data input setup time	Master	2.7 V or above	t_{SU}	10	—	ns	Figure 5.47 to Figure 5.52
			1.8 V or above		30	—		
		Slave			$25 - t_{Pcyc}$	—		
	Data input hold time	Master	RSPCK set to a division ratio other than PCLKB divided by 2	t_H	t_{Pcyc}	—	ns	
			RSPCK set to PCLKB divided by 2	t_{HF}	0	—		
		Slave		t_H	$20 + 2 \times t_{Pcyc}$	—		
	SSL setup time	Master		t_{LEAD}	$-30 + N^{*2} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	$-30 + N^{*3} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	Data output delay time	Master	2.7 V or above	t_{OD}	—	14	ns	
			1.8 V or above		—	30		
		Slave	2.7 V or above		—	$3 \times t_{Pcyc} + 65$		
			1.8 V or above		—	$3 \times t_{Pcyc} + 105$		
	Data output hold time	Master	2.7 V or above	t_{OH}	0	—	ns	
			1.8 V or above		–20	—		
		Slave			0	—		
	Successive transmission delay time	Master		t_{TD}	$t_{SPcyc} + 2 \times t_{Pcyc}$	$8 \times t_{SPcyc} + 2 \times t_{Pcyc}$	ns	
		Slave			$4 \times t_{Pcyc}$	—		
	MOSI and MISO rise/fall time	Output	2.7 V or above	t_{Dr}, t_{Df}	—	10	ns	
			1.8 V or above		—	20		
		Input			—	1	µs	
	SSL rise/fall time	Output		t_{SSLr}, t_{SSLf}	—	20	ns	
		Input			—	1	µs	
	Slave access time		2.7 V or above	t_{SA}	—	6	t_{Pcyc}	Figure 5.51, Figure 5.52
			1.8 V or above		—	7		
	Slave output release time		2.7 V or above	t_{REL}	—	5	t_{Pcyc}	
			1.8 V or above		—	6		

Note 1. t_{Pcyc}: PCLK cycle
Note 2. N: An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)
Note 3. N: An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)

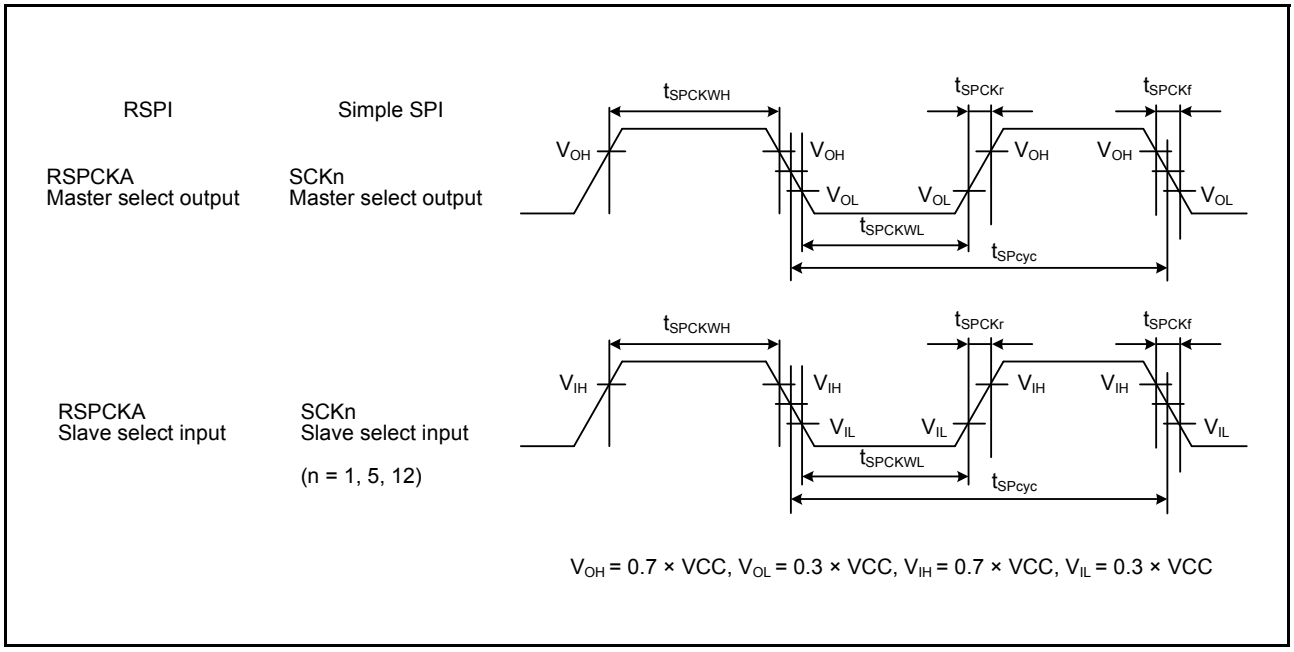


Figure 5.46 RSPI Clock Timing and Simple SPI Clock Timing

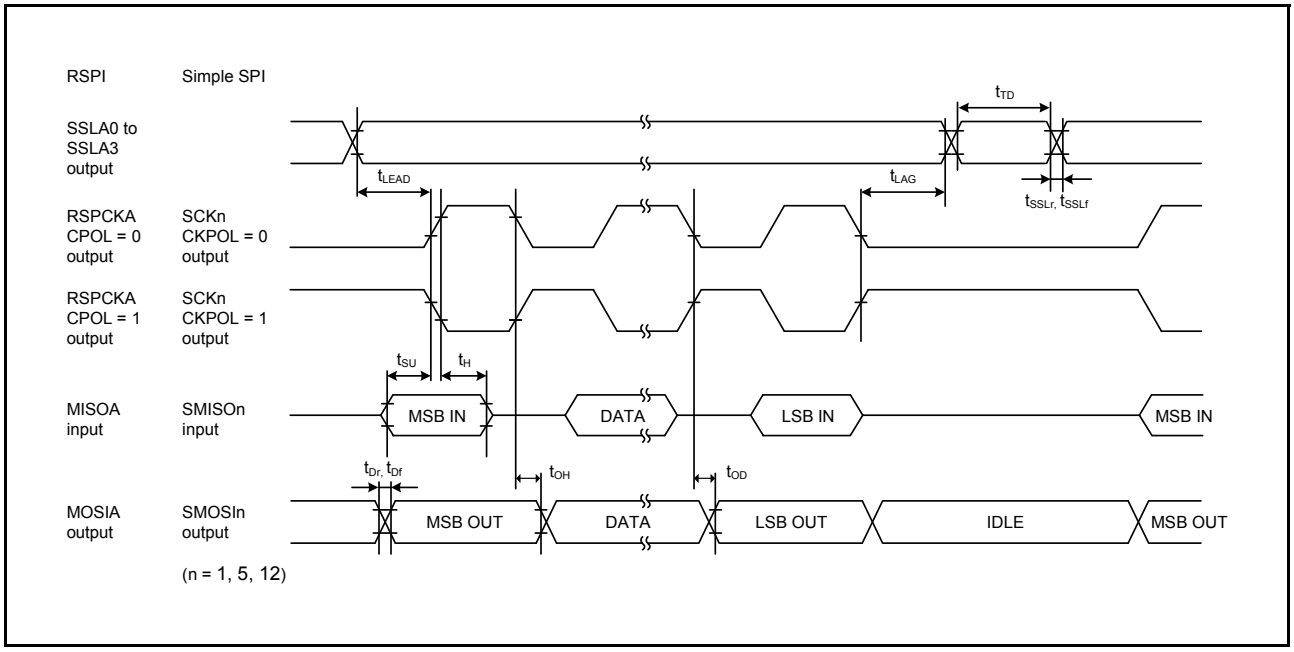


Figure 5.47 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1)

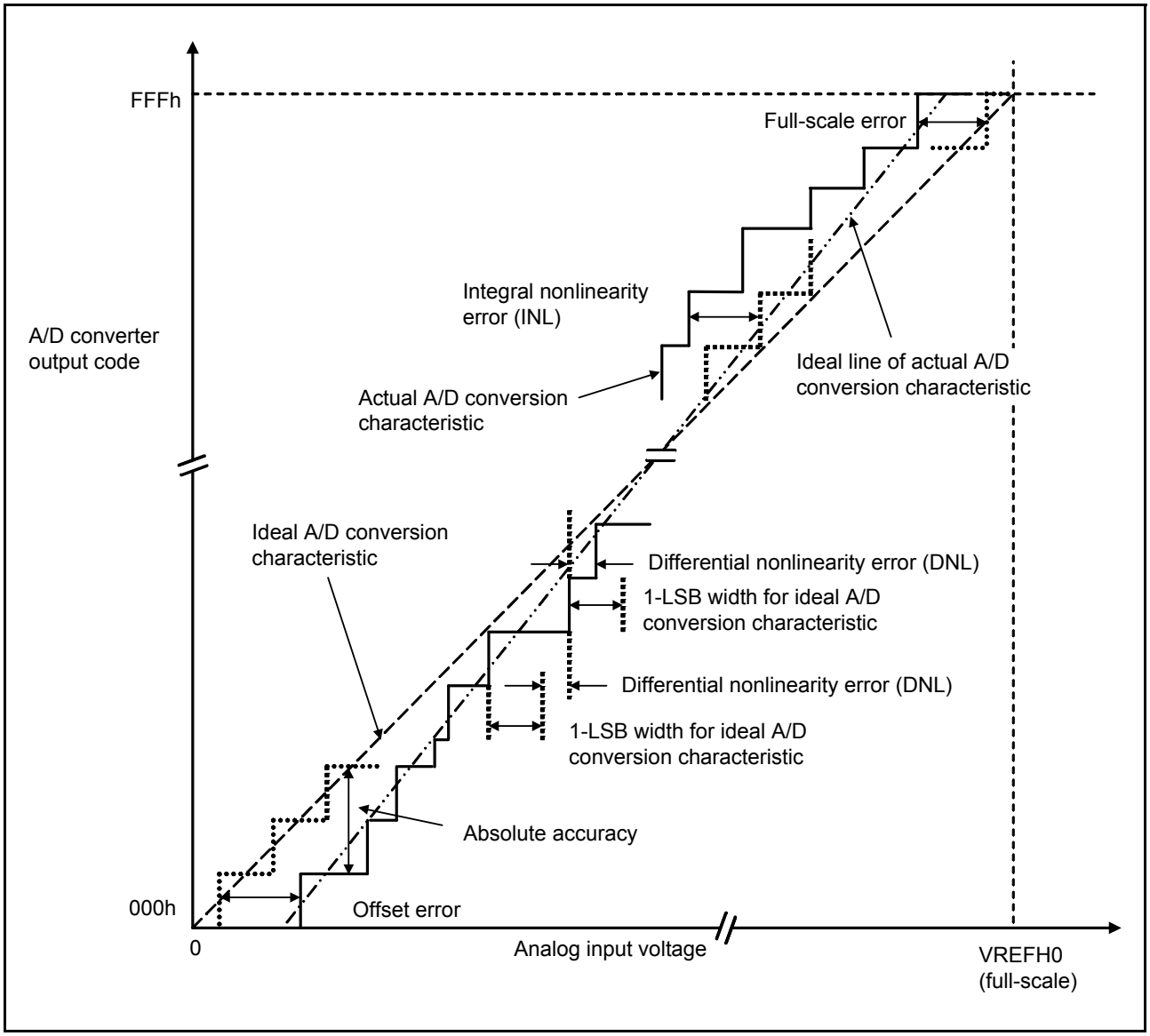


Figure 5.57 Illustration of A/D Converter Characteristic Terms

Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics, and the actual A/D conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage (VREFH0 = 3.072 V), then 1-LSB width becomes 0.75 mV, and 0 mV, 0.75 mV, 1.5 mV, ... are used as analog input voltages.

If analog input voltage is 6 mV, absolute accuracy = ±5 LSB means that the actual A/D conversion result is in the range of 003h to 00Dh though an output code, 008h, can be expected from the theoretical A/D conversion characteristics.

Integral nonlinearity error (INL)

Integral nonlinearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

Differential nonlinearity error (DNL)

Differential nonlinearity error is the difference between 1-LSB width based on the ideal A/D conversion characteristics and the width of the actually output code.

Offset error

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

Full-scale error

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

5.6 D/A Conversion Characteristics

Table 5.43 D/A Conversion Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, fPCLKB ≤ 32 MHz, T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		—	—	8	Bit	
Conversion time	VCC = 2.7 to 3.6 V	—	—	3.0	µs	35-pF capacitive load
	VCC = 1.6 to 2.7 V	—	—	6.0		
Absolute accuracy	VCC = 2.4 to 3.6 V	—	—	±3.0	LSB	2-MΩ resistive load
	VCC = 1.8 to 2.4 V	—	—	±3.5		
	VCC = 2.4 to 3.6 V	—	—	±2.0	LSB	4-MΩ resistive load
	VCC = 1.8 to 2.4 V	—	—	±2.5		
RO output resistance		—	6.4	—	kΩ	

5.7 Temperature Sensor Characteristics

Table 5.44 Temperature Sensor Characteristics

Conditions: 2.0 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.0 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy	—	—	±1.5	—	°C	2.4 V or above
		—	±2.0	—		Below 2.4 V
Temperature slope	—	—	–3.65	—	mV/°C	
Output voltage (at 25°C)	—	—	1.05	—	V	VCC = 3.3 V
Temperature sensor start time	t_{START}	—	—	5	µs	
Sampling time	—	5	—	—	µs	

5.8 Power-On Reset Circuit and Voltage Detection Circuit Characteristics

Table 5.45 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (1)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V_{POR}	1.35	1.50	1.65	V	Figure 5.58, Figure 5.59
	Voltage detection circuit (LVD1)*1	V_{det1_4}	3.00	3.10	3.20	V	Figure 5.60 At falling edge VCC
		V_{det1_5}	2.91	3.00	3.09		
		V_{det1_6}	2.81	2.90	2.99		
		V_{det1_7}	2.70	2.79	2.88		
		V_{det1_8}	2.60	2.68	2.76		
		V_{det1_9}	2.50	2.58	2.66		
		V_{det1_A}	2.40	2.48	2.56		
		V_{det1_B}	1.99	2.06	2.13		
		V_{det1_C}	1.90	1.96	2.02		
		V_{det1_D}	1.80	1.86	1.92		

Note: • These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol Vdet1_n denotes the value of the LVDLVLR.LVD1LVL[3:0] bits.

Table 5.46 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Voltage detection circuit (LVD2)*1	V_{det2_0}	2.71	2.90	3.09	V	Figure 5.61 At falling edge VCC
		V_{det2_1}	2.43	2.60	2.77		
		V_{det2_2}	1.87	2.00	2.13		
		V_{det2_3}*2	1.69	1.80	1.91		
Wait time after power-on reset cancellation	At normal startup*3	t_{POR}	—	9.1	—	ms	Figure 5.59
	During fast startup time*4	t_{POR}	—	1.6	—		
Wait time after voltage monitoring 1 reset cancellation	Power-on voltage monitoring 1 reset disabled*3	t_{LVD1}	—	568	—	µs	Figure 5.60
	Power-on voltage monitoring 1 reset enabled*4		—	100	—		
Wait time after voltage monitoring 2 reset cancellation		t_{LVD2}	—	100	—	µs	Figure 5.61
Response delay time		t_{det}	—	—	350	µs	Figure 5.58
Minimum VCC down time*5		t_{VOFF}	350	—	—	µs	Figure 5.58, VCC = 1.0 V or above
Power-on reset enable time		$t_{W(POR)}$	1	—	—	ms	Figure 5.59, VCC = below 1.0 V
LVD operation stabilization time (after LVD is enabled)		$Td_{(E-A)}$	—	—	300	µs	Figure 5.60, Figure 5.61
Hysteresis width (LVD1 and LVD2)		V_{LVH}	—	70	—	mV	Vdet1_4 selected
			—	60	—		Vdet1_5 to 9, LVD2 selected
			—	50	—		When selection is from among Vdet1_A to B.
			—	40	—		When selection is from among Vdet1_C to D.

Note: • These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

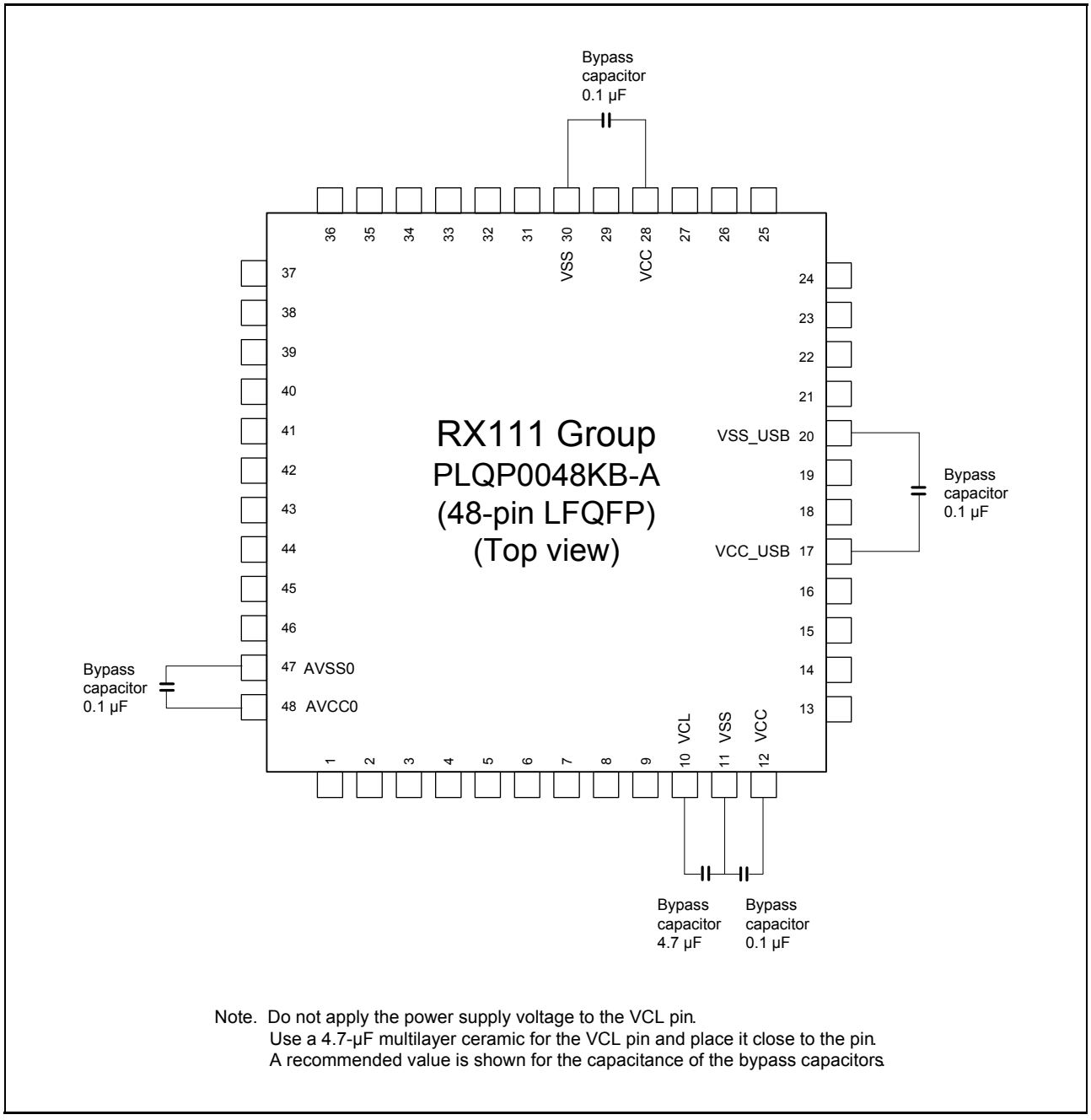
Note 1. n in the symbol Vdet2_n denotes the value of the LVDLVLR.LVD2LVL[3:0] bits.

Note 2. Vdet2_3 selection can be used only when the CMPA2 pin input voltage is selected and cannot be used when the power supply voltage (VCC) is selected.

Note 3. When OFS1.(STUPLVD1REN, FASTSTUP) = 11b.

Note 4. When OFS1.(STUPLVD1REN, FASTSTUP) ≠ 11b.

Note 5. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det0}, V_{det1}, and V_{det2} for the POR/LVD.



Note. Do not apply the power supply voltage to the VCL pin.
Use a 4.7-µF multilayer ceramic for the VCL pin and place it close to the pin.
A recommended value is shown for the capacitance of the bypass capacitors.

Figure 5.64 Connecting Capacitors (48-pin LFQFP)

NOTES FOR CMOS DEVICES

(1) VOLTAGE APPLICATION WAVEFORM AT INPUT PIN: Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between VIL (MAX) and VIH (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between VIL (MAX) and VIH (MIN).

(2) HANDLING OF UNUSED INPUT PINS: Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

(3) PRECAUTION AGAINST ESD: A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

(4) STATUS BEFORE INITIALIZATION: Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

(5) POWER ON/OFF SEQUENCE: In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current. The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

(6) INPUT OF SIGNAL DURING POWER OFF STATE : Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.